

Research Article

Growth Mechanism and Surface Structure of Ge Nanocrystals Prepared by Thermal Annealing of Cosputtered GeSiO Ternary Precursor

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Ge nanocrystals (Ge-ncs) embedded in a SiO₂ superlattice structure were prepared by magnetron cosputtering and postdeposition annealing. The formation of spherical nanocrystals was confirmed by transmission electron microscopy and their growth process was studied by a combination of spectroscopic techniques. The crystallinity volume fraction of Ge component was found to increase with crystallite size, but its overall low values indicated a coexistence of crystalline and noncrystalline phases. A reduction of Ge-O species was observed in the superlattice during thermal annealing, accompanied by a transition from oxygen-deficient silicon oxide to silicon dioxide. A growth mechanism involving phase separation of Ge suboxides (GeO_x) was then proposed to explain these findings and supplement the existing growth models for Ge-ncs in SiO₂ films. Further analysis of the bonding structure of Ge atoms suggested that Ge-ncs are likely to have a core-shell structure with an amorphous-like surface layer, which is composed of GeSiO ternary complex. The surface layer thickness was extracted to be a few angstroms and equivalent to several atomic layer thicknesses.

1. Introduction

During the last couple of years germanium nanocrystals (Gencs) have attracted increasing research interest as a promising material for optoelectronics and charge storage applications [1-5]. To this day, two approaches have been predominantly used for the fabrication of Ge-ncs. One of them is the Stranski-Krastanov growth that produces self-assembled Gencs on foreign substrates or in Ge/Si superlattice structures [6, 7], while the other one forms crystallites via a classical nucleation process and the produced Ge-ncs are dispersed in a matrix composed of high band gap materials. So far, the most widely studied matrix material is amorphous silica due to its high temperature stability and compatibility to versatile preparation methods [8-12]. In this case, a germanium rich SiO₂ layer is first deposited as a precursor for crystallization and then thermal annealing is used to change the precipitation to Ge-ncs at nucleation sites.

In our recent work, we managed to fabricate Ge-ncs embedded in a SiO₂ superlattice structure (Ge-ncs:SiO₂) by magnetron cosputtering and postdeposition annealing [13, 14]. It was confirmed by independent techniques that the Ge-ncs have good crystallinity and their size can be modulated by altering the layer thickness, resulting in tunable optical absorption and luminescence behaviour. These results are quite interesting and open a new perspective to the implementation of Ge-ncs with designed properties. However, despite the tremendous advances in preparation techniques, there is still much scope for systematic studies of this nanocomposite. Since germanium is fairly active in an oxygen environment, the formation process of Ge-ncs in SiO₂ thin films could become rather complex and is worth exploring. In the meantime, the understanding of the microstructure of Ge-ncs:SiO₂ is still incomplete, particularly the surface region where the atoms of crystallite contact the atoms of oxide matrix. In fact, the surface or interfacial layer

is believed to have great impact on various properties of nanocrystals, and in turn its structure could be affected by external circumstance [15–17].

In this paper, the growth mechanism and surface structure of Ge-ncs:SiO₂ were studied experimentally and theoretically. The formation of spherical Ge-ncs was observed by high resolution lattice image. The structural properties of Gencs were characterized for different growth stages and the evolution of crystallinity volume fraction of Ge component was extracted and analyzed. Meanwhile, the infrared absorption properties of as-deposited and postannealed samples were compared to reveal the variation of chemical composition and stoichiometry of the superlattice during the nanocrystal growth. A possible mechanism was proposed based on the experimental results to make the growth model of Ge-ncs more complete. Furthermore, the microstructure of the surface layer of Ge-ncs:SiO₂ was investigated and a simple method was adopted to calculate the thickness of the surface layer.

2. Materials and Methods

Ge-ncs:SiO₂ were fabricated by RF magnetron sputtering and thermal annealing. The sputtering target was a 4-inch circular fused silica plate uniformly partially covered with a few pieces of fan-shaped Ge strips (99.9999% purity). The growth chamber was pumped down to a base pressure of 3.0×10^{-4} Pa and the thin films were deposited at 25 W power. In order to form a multilayered superlattice, alternative layers of Ge-rich SiO₂ (GeRSiO) and a mixture of stoichiometric oxides (GeO₂/SiO₂) were deposited by argon sputtering and by reactive sputtering with argon and oxygen mixture, respectively. In all the samples, the sputtering time was 6 min for individual GeRSiO layer as well as for individual GeO₂/SiO₂ layer. On top of the multibilayer structure a thick GeO₂/SiO₂ capping layer was grown to prevent possible penetration of moisture and oxidation of Ge-ncs during storage. The film growth was followed by thermal annealing for different time periods at around 685°C in vacuum, in situ in the sputtering chamber.

Ge-ncs and the multilayered thin films were analyzed by a series of characterization techniques. Direct physical evidence of the formation of Ge-ncs was obtained by transmission electron microscopy (TEM). The average crystallite sizes were estimated by glancing incidence X-ray diffraction (XRD) using Cu K α radiation ($\lambda = 0.154$ nm), operating at 45 kV and 40 mA. The glancing angle between the incident Xray and the sample surface was 0.3°. Raman spectra were measured by a micro-Raman spectrometer in a backscattering configuration. The Ar ion laser has a wavelength of 514.4 nm and the power of laser was lowered to 2 mW (spot size of ~ $14 \,\mu\text{m}^2$) to avoid any spurious crystallization induced by laser heating. The infrared absorption spectra were measured by Fourier transform infrared spectroscopy (FTIR) with a resolution set at 4 cm⁻¹ to study the chemical composition and stoichiometry of the superlattices. The bonding structure of Ge atoms was acquired by X-ray photoelectron spectroscopy



FIGURE 1: TEM image of Ge-ncs embedded in SiO_2 matrix. The inset shows lattice fringes inside the Ge-nc indicated by arrow.

(XPS) which employs a monochromatic Al K α (1486.5 eV) Xray source with a power of 10 kV×12 mA and a hemispherical energy analyzer.

3. Results and Discussion

The direct physical evidence of Ge-ncs produced in glassy oxide matrices was obtained with TEM, as illustrated in Figure 1. Lattice fringes inside the nanocrystals are clearly identified in the inset and their spacing distance is measured to be ~0.33 nm corresponding to the 111 planes of the Ge diamond structure. It is also noticed that the nanocrystals tended to be spherical in shape although a preferred inplane crystal growth occasionally occurred. However, from this image, it is difficult to determine whether there is an interfacial layer between the crystalline Ge core and the amorphous SiO₂ matrix. This might be ascribed to the weak material contrast or the extremely thin thickness of the interfacial layer, which is beyond the resolution of our equipment.

In order to investigate the microstructure evolution of Ge-ncs:SiO₂, a group of samples at different growth stages were prepared and characterized. The Raman spectra of superlattices annealed at 685°C for different durations are shown in Figure 2. The onset of Ge crystallization was found to take place within the first 6 min of annealing, but the noticeable amorphous hump indicates that it was still an early stage of crystallite growth. As annealing duration increased, the phonon peaks of Ge-ncs became sharper and narrower, while the amorphous humps were gradually weakened. X-ray diffractograms presented in Figure 3 have been used to calculate the average size of Ge-ncs from the {111} peak broadening using the Scherrer equation [18], and the variation of crystallite size with annealing duration is shown in the figure as well. The nanocrystallite size initially increased with annealing duration but approached an upper limit after 15 min. Two mechanisms may be responsible for this phenomenon. First, the thermodynamic equilibrium condition was achieved and higher annealing temperature was required for further nanocrystal growth. On the other hand, it is also possible that the crystallite growth in GeRSiO



FIGURE 2: Raman spectra of the superlattices annealed at 685°C for 6 min, 10 min, 15 min, and 25 min, respectively.

layers was confined by neighboring $\text{GeO}_2/\text{SiO}_2$ barrier layers [13].

The crystallinity volume fraction of Ge component in the superlattices was extracted from the Raman spectra in Figure 2 to more deeply probe the nanocrystal growth process. By comparing with as-deposited amorphous film (or, namely, noncrystalline film), the Raman spectra of superlattices containing Ge-ncs can resolve into two parts: the integrated crystalline intensity I_c and the integrated amorphous intensity I_a . The volume fraction of crystallinity ρ_c is then obtained by [19]

$$\rho_c = \frac{\rho'}{\rho' + \gamma (1 - \rho')} \text{ with } \rho' = \frac{I_c}{I_c + I_a},$$
(1)

where $I_c = \sum_c \rho_c$, $I_a = \sum_a \rho_a$ (\sum is the integrated backscattering cross section over the measured frequency range), and $y = \sum_c / \sum_a$ is the ratio of the integrated Raman cross section of the TO mode of crystalline and amorphous parts. In the case of spherical nanocrystallites with *d* (diameter) larger than 3 nm, the value of *y* in (1) can be expressed as [20]

$$y(d) = 0.1 + e^{-(d/250)}$$
 (2)

An example of the decomposition of Raman spectra is illustrated in Figure 4. The fitting curves I_{c1} (peaks at 299.9 cm⁻¹) and I_{c2} (peaks at 293.2 cm⁻¹) belong to the crystalline component, while $I_{\alpha 1}$ (peaks at 276.7 cm⁻¹) and $I_{\alpha 2}$ (peaks at 230.9 cm⁻¹) belong to the amorphous component. Then ρ_c can be calculated using (1) and (2) given the crystallite diameter, or in other words the Scherrer crystallite size. The same treatment has been applied to all the samples and ρ_c is plotted in Figure 5 as a function of annealing duration. It is seen that ρ_c has a similar variation trend as that of crystallite size, and the low values of ρ_c (maximum at 45.5%) indicate a coexistence of crystalline and noncrystalline phases in our samples.

The growth of crystallites during thermal annealing demonstrated by Raman and XRD results suggests that the formation of Ge-ncs:SiO₂ is within the framework of classical nucleation theory which includes two basic procedures, the diffusion of Ge atoms or clusters to the nearest nuclei and the continuous formation of Ge-Ge bonds. Even though it seems like a simple concept, the actual growth kinetics could be more complicated and involve some unexpected features. In a further development of the underlying thermodynamics, we investigated the variation of chemical composition and stoichiometry of the superlattices during the nanocrystal growth. The normal incidence infrared absorption spectra were measured from both the as-deposited and postannealed samples as shown in Figure 6. In addition to the characteristic peaks of SiO₂ at 436, 810, and 1033 cm⁻¹, the as-deposited sample also shows a peak that can be associated with Ge-O defect species at 706 cm⁻¹ [21, 22]. In contrast, the annealed sample exhibits very different absorption properties. The center of the Si-O-Si asymmetric stretching band shifts from 1033 to 1070 cm^{-1} , while the full width at half maximum (FWHM) of the band decreases from 158 to 92 cm⁻¹. Similar effects are also observed for the absorption band at 436 cm⁻¹. Such blue shift of peak position and decrease of bandwidth are probably attributed to the transition from oxygen-deficient oxide (SiO_x, 1 < x < 2) to dioxide in the matrix [23, 24]. In the meantime, the vanishing of the band at 706 cm⁻¹ after annealing indicates that O-vacancy complex related to Ge-O defect species is significantly reduced. Based on these results, we propose an additional mechanism to supplement the former mentioned nucleation growth model. During the cosputtering of the GeRSiO layer, part of the incorporated Ge atoms form chemical bonds with oxygen atoms, thus leading to a substoichiometric thin film composed of Si suboxide (SiO_{y}) and Ge suboxide (GeO_{y}) . In the following annealing step, phase separation would occur in Ge suboxide if the temperature is higher than 500°C [25-27], and this supplies Ge atoms for the precipitation of nanocrystals. The overall reaction formula of this process is described as follows:

$$(2 - x) \operatorname{GeO}_{y} + y \operatorname{SiO}_{x} \longrightarrow (2 - x) \operatorname{Ge} + y \operatorname{SiO}_{2}$$
 (3)

So far the growth mechanism of Ge-ncs:SiO₂ is further complemented by the awareness of the presence of Ge suboxide in the sputtered thin films. It is noted that the oxygen rich environment has a significant impact on the bonding structure of deposited germanium. In the same manner, the surface layer of Ge-ncs formed under high temperature conditions might also have been influenced by the surrounding oxide matrix. Therefore, XPS spectra around the core level Ge3d electrons as displayed in Figure 7 have been employed to examine the bonding structure of Ge atoms in the annealed samples. Besides the sharp peak corresponding to Ge-ncs (at binding energy of ~29.3 eV), the spectra exhibit a small hump between 31 eV and 33 eV, which can be ascribed to a mixture of Ge substoichiometric oxides (GeO_x, where x < 2). Because of aforementioned phase separation effect, we conjecture that these Ge-O species are more likely to exist in the surface layer of nanocrystals than in the matrix [28]. In fact, it has been reported that in



FIGURE 3: (a) XRD diffractograms of the superlattices annealed at 685°C for different annealing durations and (b) average size of Ge-ncs as a function of annealing duration.



FIGURE 4: The Gaussian fit of Raman spectra for the sample annealed at 685°C for 6 min. Fit curves I_{c1} and I_{c2} correspond to the crystalline component while $I_{\alpha 1}$ and $I_{\alpha 2}$ correspond to the amorphous component. During the fit procedure, the peak positions are limited to specific ranges, while other parameters are unbounded.

some circumstances Ge-ncs have a core-shell structure with crystalline core and amorphous shell [29–31]. In our oxygen rich environment, the surface atoms of Ge-ncs tend to be terminated by oxygen atoms. Although the exact bonding structure and atomic number ratio is difficult to determine because of uncertainty in the local chemical composition and stoichiometry, it is still reasonable to expect that a thin layer



FIGURE 5: The crystallinity volume fraction (ρ_c) of Ge component in the superlattices as a function of annealing duration.

composed of GeSiO ternary complex is likely formed around the crystalline Ge core. An example of the surface structure is schematically illustrated in Figure 8. One thing to note here is the disordering of surface atoms which could be the cause of the amorphous-like vibration modes observed in the Raman spectra of Figure 2. Thus, by assuming that the surface layer is solely responsible for these noncrystalline components, we are able to use the following equation to roughly estimate the surface layer thickness in our Ge-ncs which are fairly spherical in shape:

$$\rho_c = \left[\frac{r_c}{(r_c + t_s)}\right]^3,\tag{4}$$



FIGURE 6: FTIR spectra of as-deposited and postannealed superlattices. The numbers label the wavenumbers of different peaks.



FIGURE 7: XPS spectra of Ge-ncs:SiO₂ annealed at 670° C for 25 min. The small hump indicated by dashed ellipse is related to the Ge suboxide species (GeO_x).

where t_s is the thickness of the surface layer and r_c is the radius of the cryptocrystalline Ge-nc core which approximates to half of the crystallite size measured from XRD. The superlattice annealed for 25 min with a ρ_c of 45.5% has been chosen for the thickness calculation, because the nanocrystal growth process was completed in this sample. The derived thickness of surface layer is about 6.6 Å which is equivalent to a few atomic layer thicknesses and agrees well with previously reported results [29–33]. It should be aware that a thickness of this order of magnitude is very difficult to be detected by the TEM measurement, which explains



FIGURE 8: Schematic diagram of the surface layer of Ge-ncs:SiO₂, which illustrates the GeSiO ternary component and the dangling bonds (DBs).

why this surface layer is not observed in Figure 1. Moreover, the real thickness of surface layer should be even less than the calculated values, because other components may also contribute to the noncrystalline phase of the superlattices, such as the noncrystallized Ge atoms or clusters remaining in SiO₂ matrix. Nevertheless, we expect that the surface layer effect dominated in our samples.

4. Conclusions

Ge-ncs embedded in SiO₂ superlattices were fabricated and studied experimentally and theoretically. TEM micrograph confirms the formation of Ge-ncs with spherical shape and diamond structure. A group of samples annealed for different time periods were characterized to enable the understanding of the nanocrystal growth process. The Raman results show that, as annealing proceeded, there was a continuous improvement of film crystallinity. The average sizes of Ge-ncs were calculated from the X-ray peak broadening and it can be inferred that the nanocrystal growth was completed after 25 min annealing. The crystallinity volume fraction extracted from Raman spectra exhibited a variation tendency similar to that of crystallite size, and its overall low values suggested a coexistence of crystalline and noncrystalline phases in our samples. The measurement of infrared absorption spectra reveals that the Ge-O species was significantly reduced during the nanocrystal growth, and simultaneously the oxygendeficient silicon oxide was changed to silicon dioxide in the matrix. Based on these observations, a growth mechanism involving phase separation of Ge suboxides (GeO_r) was developed to supplement the existing growth models for Gencs in SiO₂ films. Moreover, the bonding structure of Ge atoms was examined to study the surface structure of Gencs:SiO₂. Preliminary results show that Ge-ncs are likely to have an amorphous-like surface layer composed of GeSiO ternary complex. The surface layer thickness was further determined from the crystallinity volume fraction and was in the order of angstroms, which is equivalent to a few atomic layer thicknesses.

Conflict of Interests

The authors declare that there is no conflict of interests regarding the publication of this paper.

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